

RX72M Group

R01AN6749EJ0101

Rev.1.01

Nov 30, 2023

CPU Card EtherCAT Startup Manual

Introduction

This application note is a quick start guide for EtherCAT[®] communication with the RX72M CPU Card for industrial network evaluation.

Target Device

RX72M

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1. Operating environment

The sample program in this manual assumes the following environment.

Table 1.1 Operating environment

Item	Detailed content
Evaluation board	Renesas Electronics RX72M CPU Card Model name: RTK0EMXDE0C00000BJ
CPU	RX CPU (RXv3)
Operating frequency	CPU Clock (CPUCLK) : 240MHz
Operating voltage	3.3V
Operation mode	<ul style="list-style-type: none"> • Single chip mode • Boot mode (SCI interface) • Boot mode (USB interface) • Boot mode (FINE interface)
Device	R5F572MNDDBD <ul style="list-style-type: none"> • Code flash memory Capacity: 4 Mbytes ROM cache: 8 Kbytes • Data flash memory Capacity: 32 Kbytes • RAM/extended RAM Capacity: 512 Kbytes / 512 Kbytes
Communication protocol	EtherCAT
IDE	CCRX compiler (V3.05.00 or later) + e2Studio(2023-10 or later) IAR Embedded Workbench for Renesas RX (V5.10.1 or later) Smart Configurator for RX (V2.19.0 or later)
Emulator	Renesas Electronics E2 On-Board (hereinafter, referred to as "E2OB")
SSC Tool	EtherCAT Technology Group (ETG) Slave Stack Code (SSC) Tool Version 5.13 or later
SoftwarePLC	Beckhoff Automation TwinCAT® 3 (Download from Beckhoff web site)

Note). SSC Tool, the installation of the software PLC shall have been completed.

2. Setting up and connecting the Communication board

For detailed information on this board, refer to the "RX72M CPU Card with RDC-IC User's Manual" (R12UZ0098EJ0100).

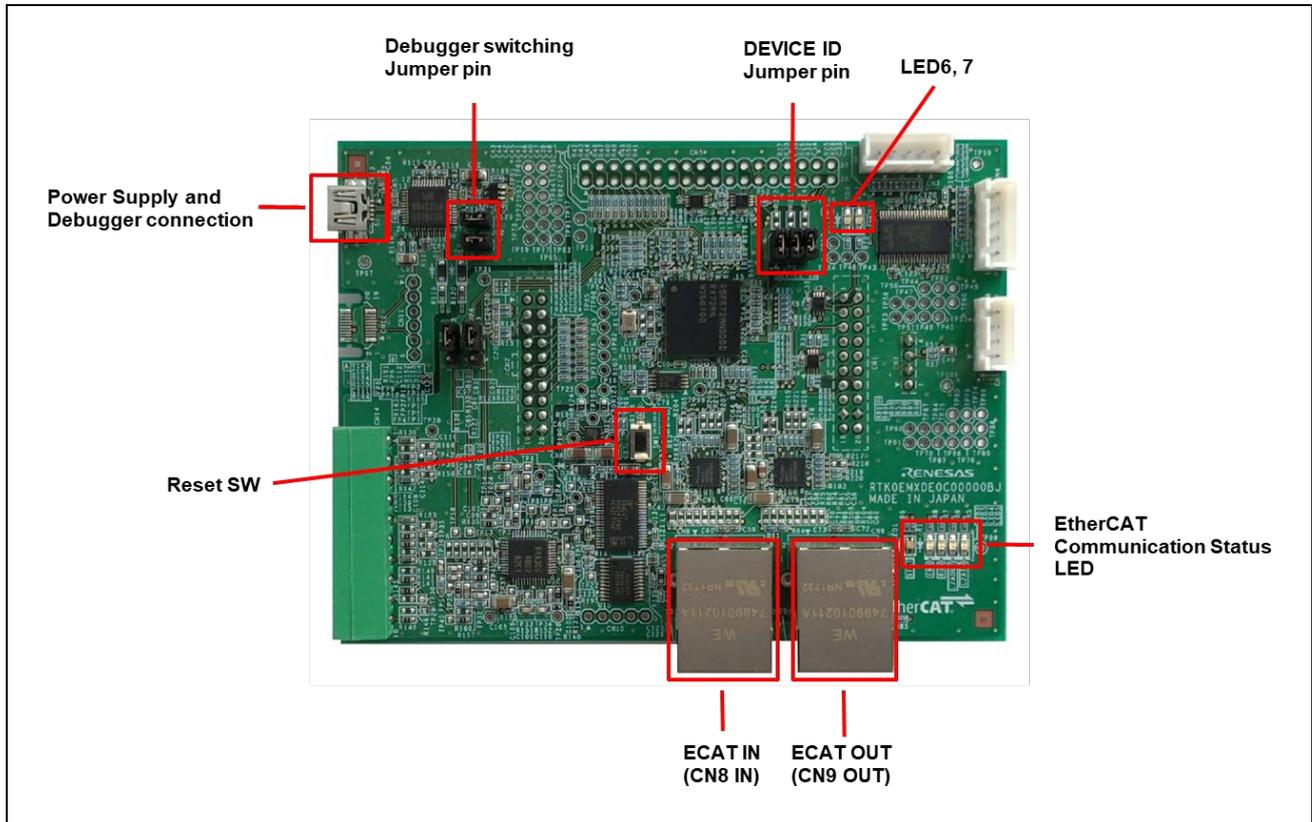


Figure 1.1 RX72M CPU Card configuration

2.1 CPU Card setting

Set the jumper pins before powering on the CPU Card.

Using E2OB : Short the Debugger switching Jumper pin.

Setting the device ID: Short the DEVICE ID Jumper pin (JP5) according to the ID.
Equivalent to Bit "1" in short.

2.2 Power supply selection

CPU Card does not have DC Jack, input DC5V from USB connector.

2.3 Connection of communication board

Connect each cable as follows.

- (1) Connect an Ethernet cable (Category 5 or higher is recommended) to the Ether port (CN8 IN).
- (2) Connect the common USB connector for the emulator and power supply to the host computer.

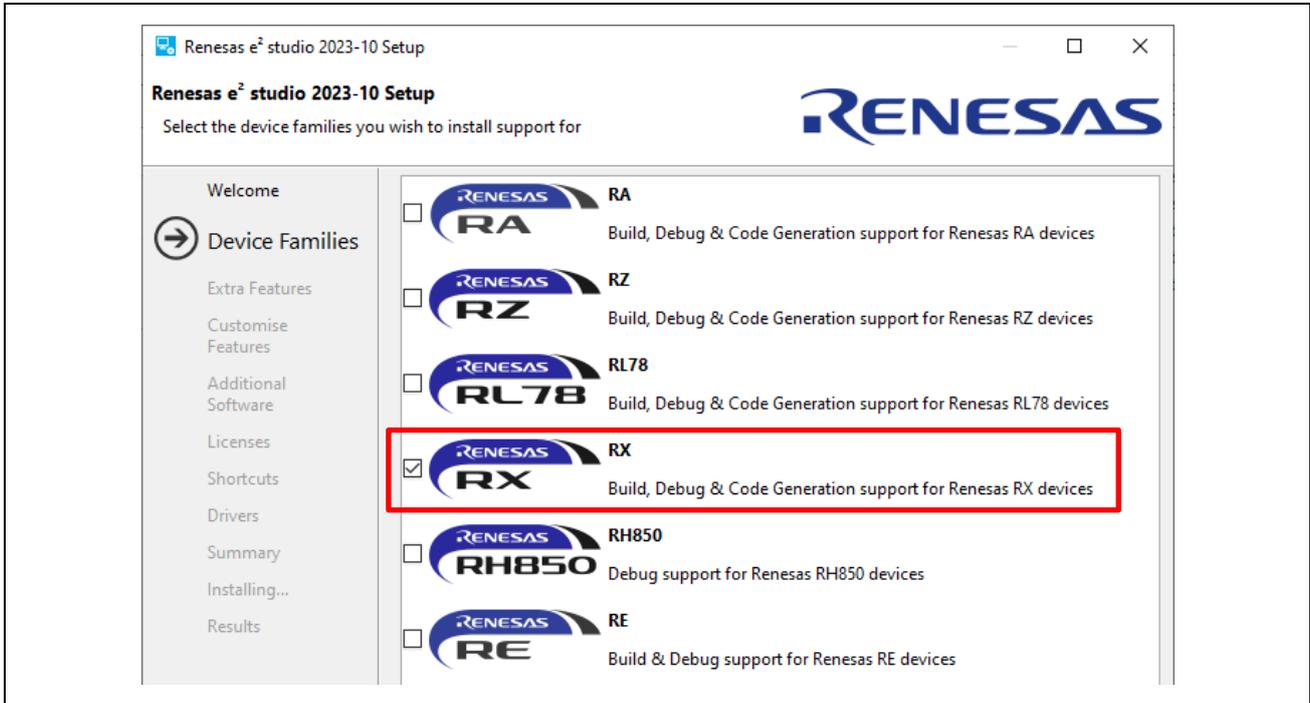
3. Installation of e2studio

Download the e² studio for RX72M (2023-10 or later) from the Web site below.

https://www.renesas.com/e2studio_download

3.1 Installing the CC-RX Compiler V3.05.00

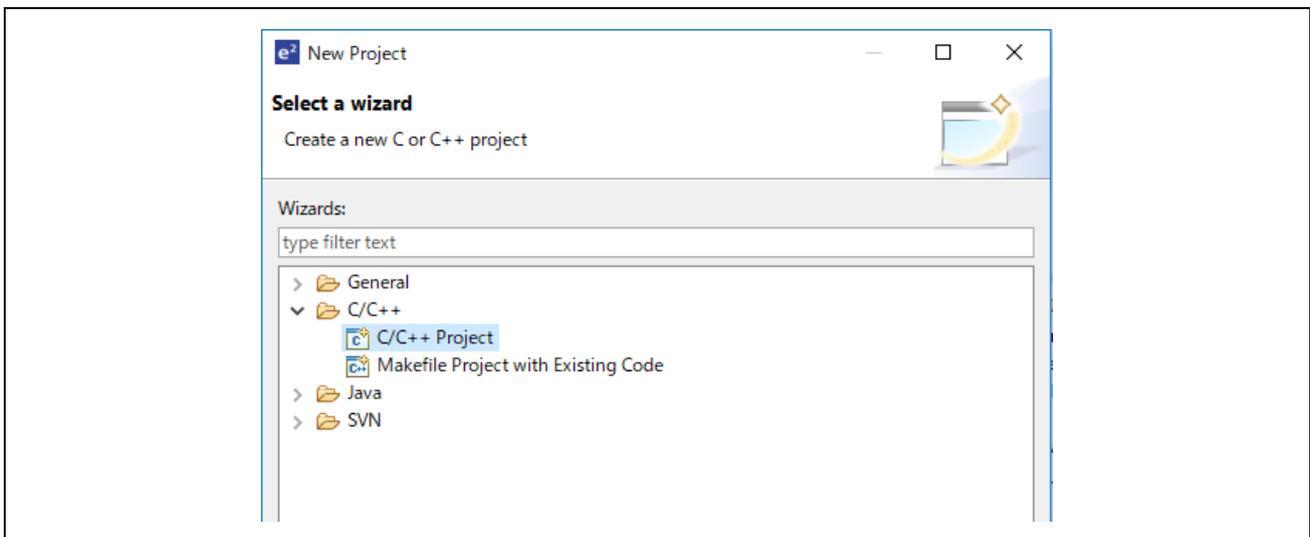
The device families selection dialog box appears while installing the e² studio. Click [RX] and install. CC-RX V3.05.00 Compiler for RX72M will be installed with the e² studio.



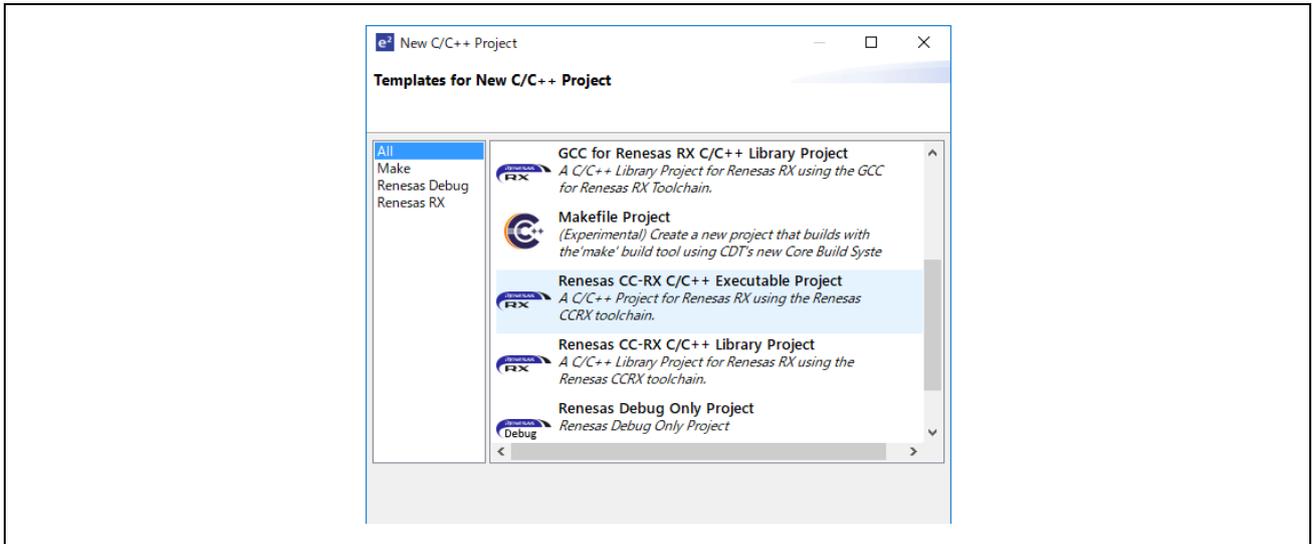
3.2 How to check the registered Compiler

(1) Start the e² studio from the Windows Start menu.

(2) Select [File] → [New] → [C/C++Project] → [Next].



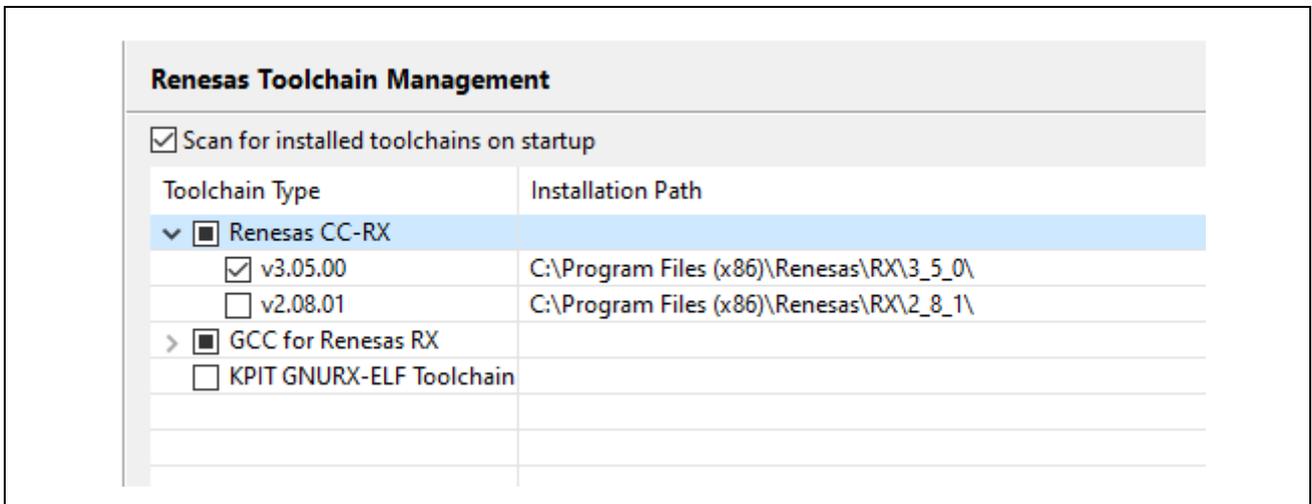
(3) In the [Templates for New C/C++ Project] dialog box, select [Renesas RX] → [Renesas CC-RX C/C++ Executable Project] → [Next].



(4) In the [New Renesas CC-RX C/C++ Executable Project] dialog box, enter a desired project name and select [Next].

(5) In the [Select toolchain, device & debug settings] dialog box, select [Manage Toolchains...] under [Toolchain Settings].

(6) In the [Renesas Toolchain Management] dialog box, the registration was successful if "v3.05.00" has been added under "Renesas CCRX".



4. Import EtherCAT slave stack code into Sample Program

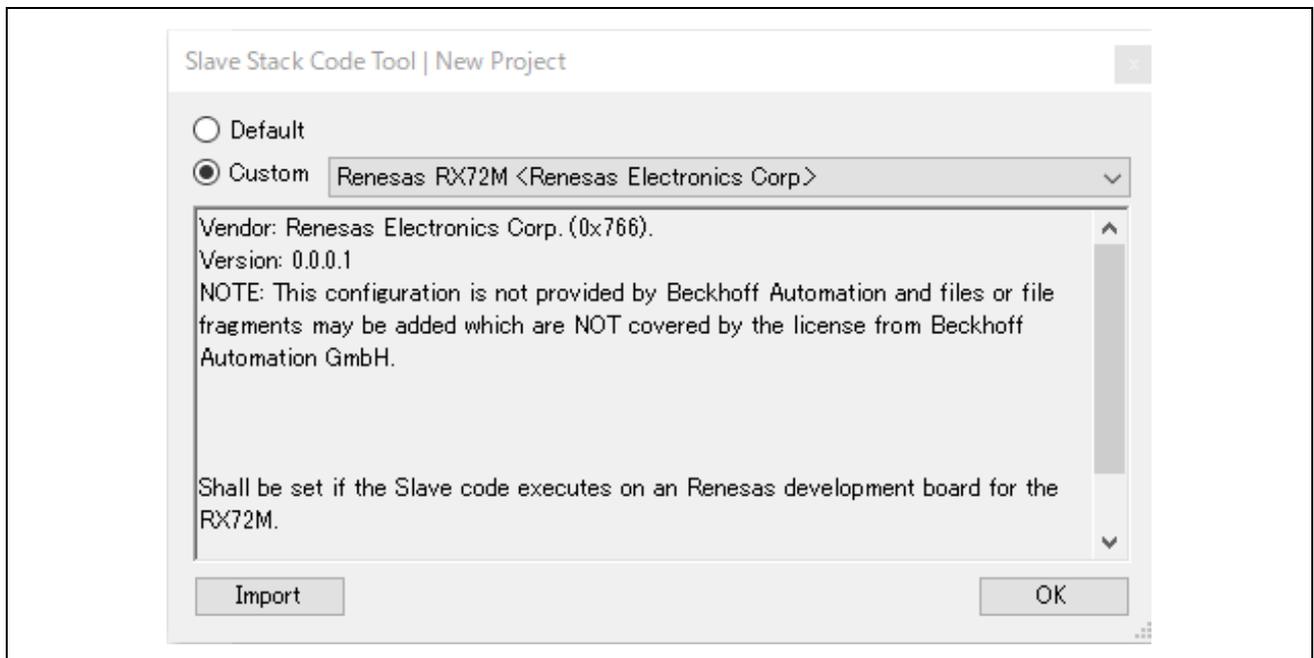
* EtherCAT slave stack code is not included in this sample project.

* "EtherCAT Slave Stack Code (SSC) Tool" is required to generate EtherCAT slave stack code.

* SSC Tool is available from the ETG Association.

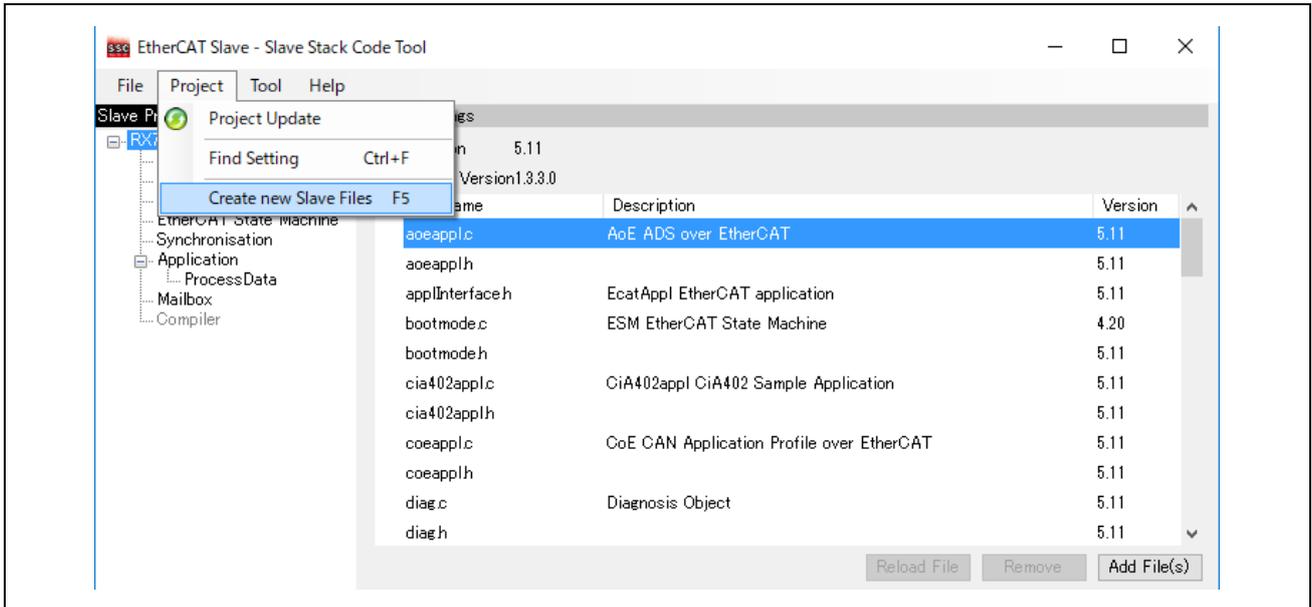
This sample program is provided in the form of "ecat_demo_cpurx72m.zip", so unzip it in any folder in advance.

- (1) Start the SSC Tool by clicking [EtherCAT Slave Stack Code] → [SSC Tool] from the Windows start menu.
- (2) In the New Project dialog, click Import, select the following SSC Tool configuration file in the sample program folder, and click [OK].
ecat_demo_cpurx72m\src\smc_gen\r_ecat_rx\utilities\rx72m\ssc_config\Renesas_RX72M_config.xml
- (3) Check the [Custom] check box and select "Renesas RX 72 M <Renesas Electronics Corp>" from the list and click [OK].

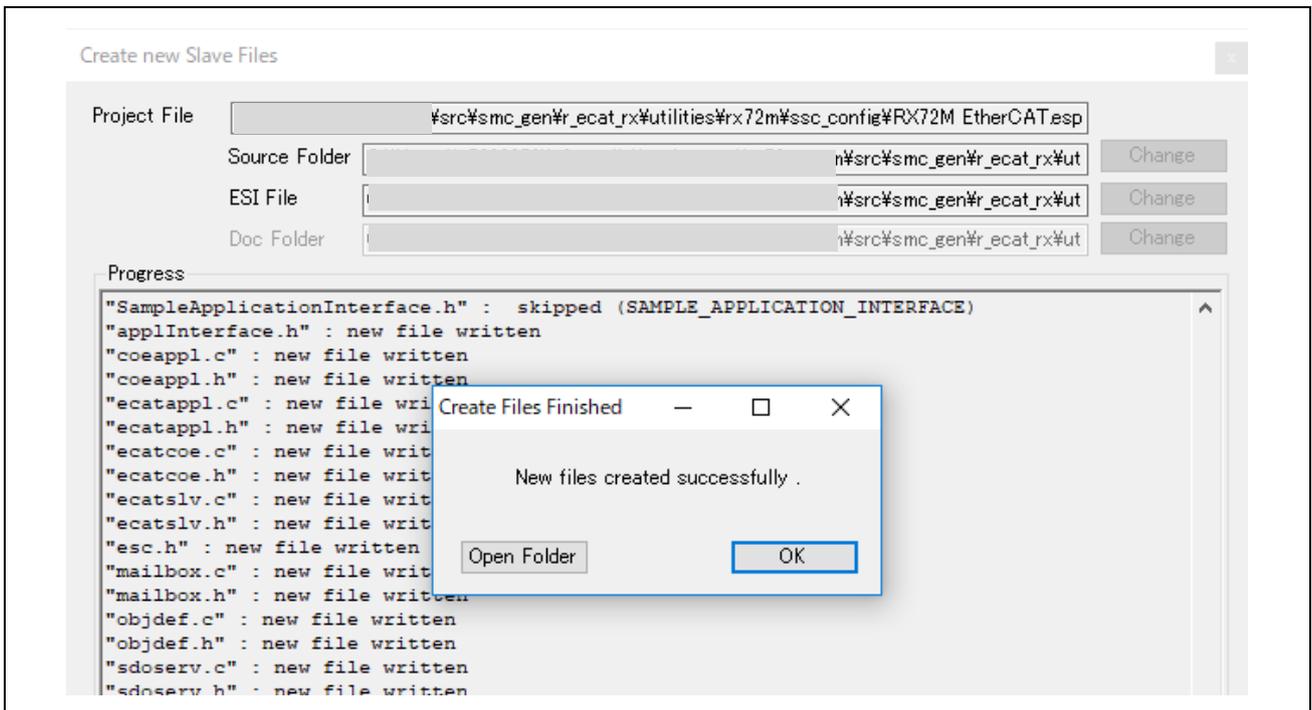


- (4) Click [File] -> [Save] and save the project with an arbitrary project file name. (It becomes "RX 72 M EtherCAT.esp" by default)

(5) Click [Project] → [Create New Slave Files] Click [Start] on the [Current new Slave Files] dialog.



(6) Source code is generated, and when it succeeds "New Files created successfully" is displayed, so click [OK].



- (7) Move the generated EtherCAT slave stack code to the source folder of your EtherCAT application.

Source folder:

`ecat_demo_cpurx72m\utilities\ssc_config\Src`

Move destination folder:

`ecat_demo_cpurx72m\project\src\application\ecat\beckhoff`

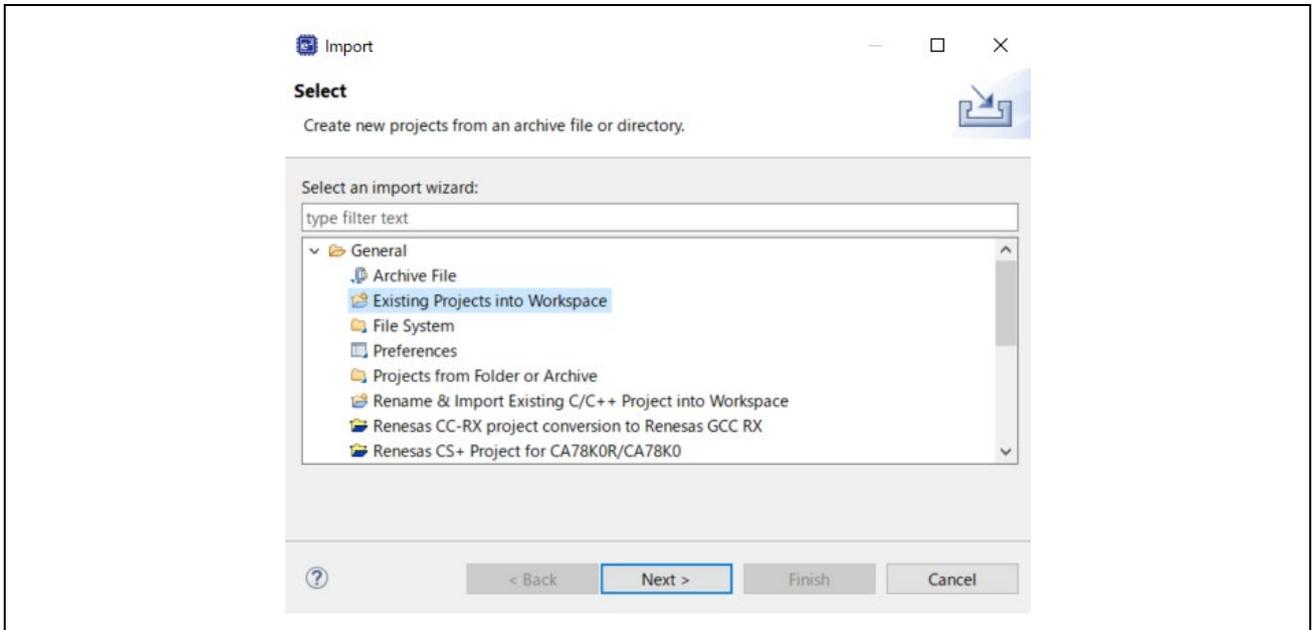
5. Import EtherCAT FIT module into e2studio

The EtherCAT FIT module is not included in the RX Driver package, so if you want to use it as a software component of the smart configurator other than the sample project, you need to manually install it in e2studio.

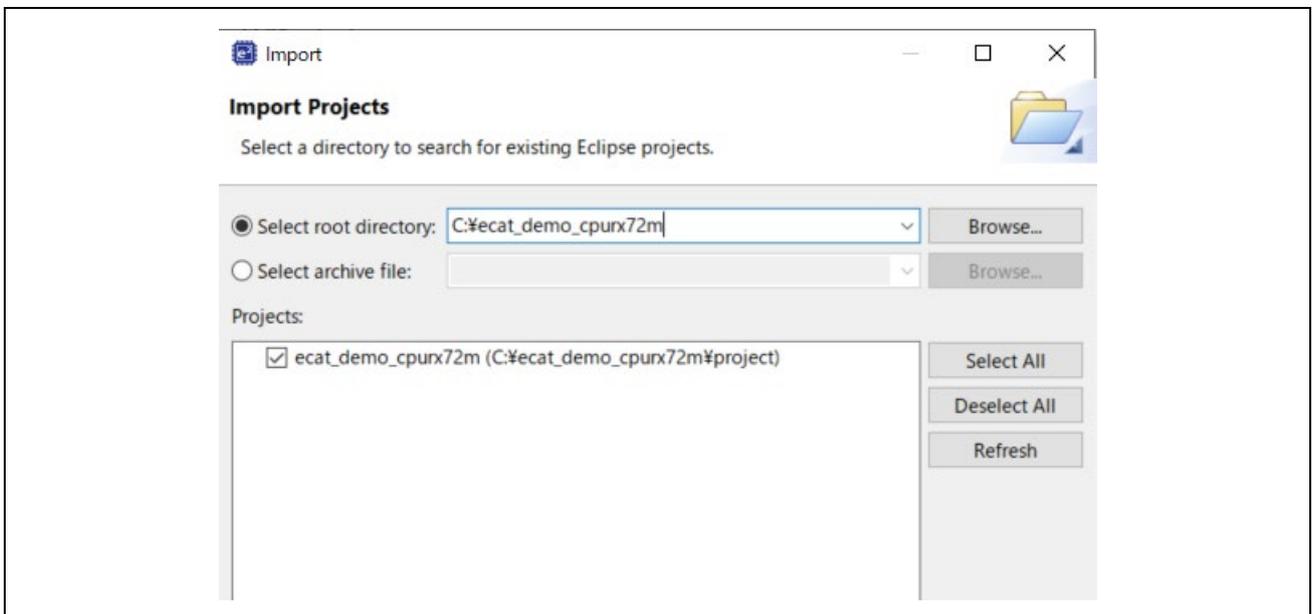
For details, refer to Chapter 6.2 of "r01an4881xx0131-rx-ecat.pdf" in advance and incorporate the module.

6. Import sample projects into e2studio

- (1) Click [File] → [Import].
- (2) In the [Select] dialog, select [General] → [Move existing project to workspace] and click [Next].



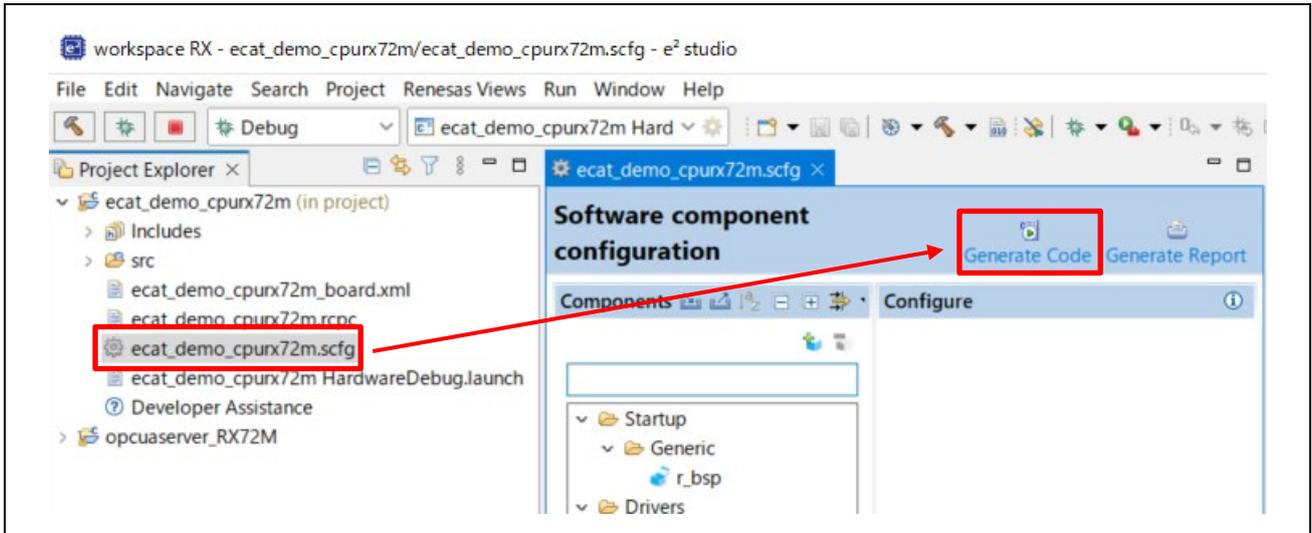
- (3) Select the [Select root directory] check box in the [Import Project] dialog box and click [Browse].
- (4) Select "ecat_demo_cpurx72m" which is a sample project for communication board and click [Open].



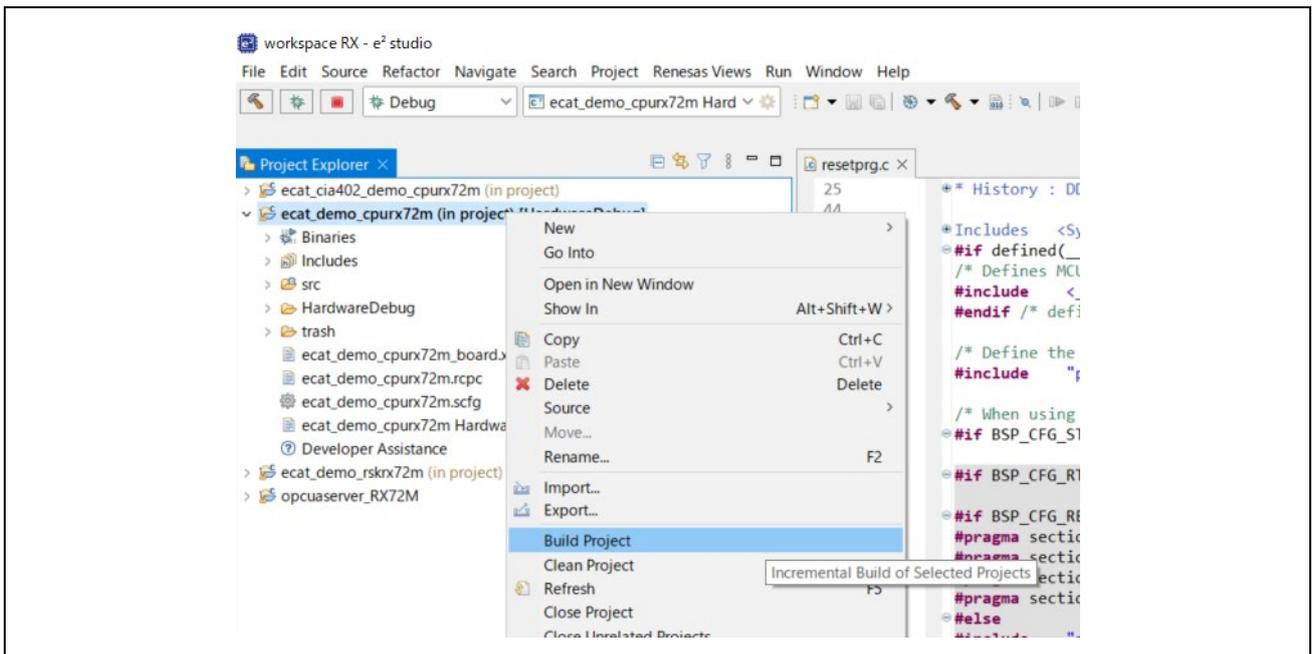
- (5) Check "ecat_demo_cpurx72m" in [Project] and click [Next] to import the project.

7. Programming and Debugging

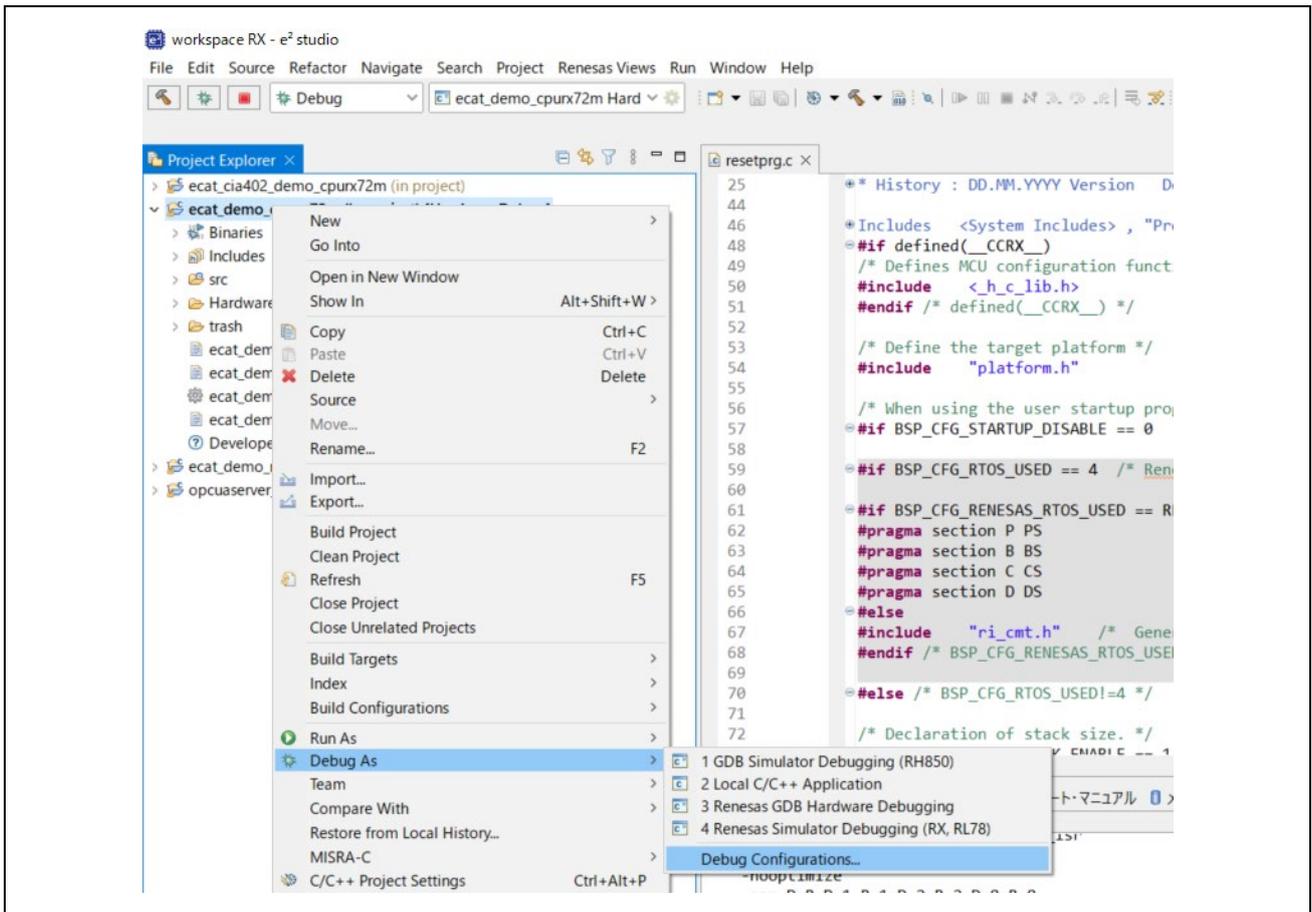
- (1) In the Project Explorer, Double-click on the "ecat_demo_cpurx72m.scfg", and execute [Generate Code]



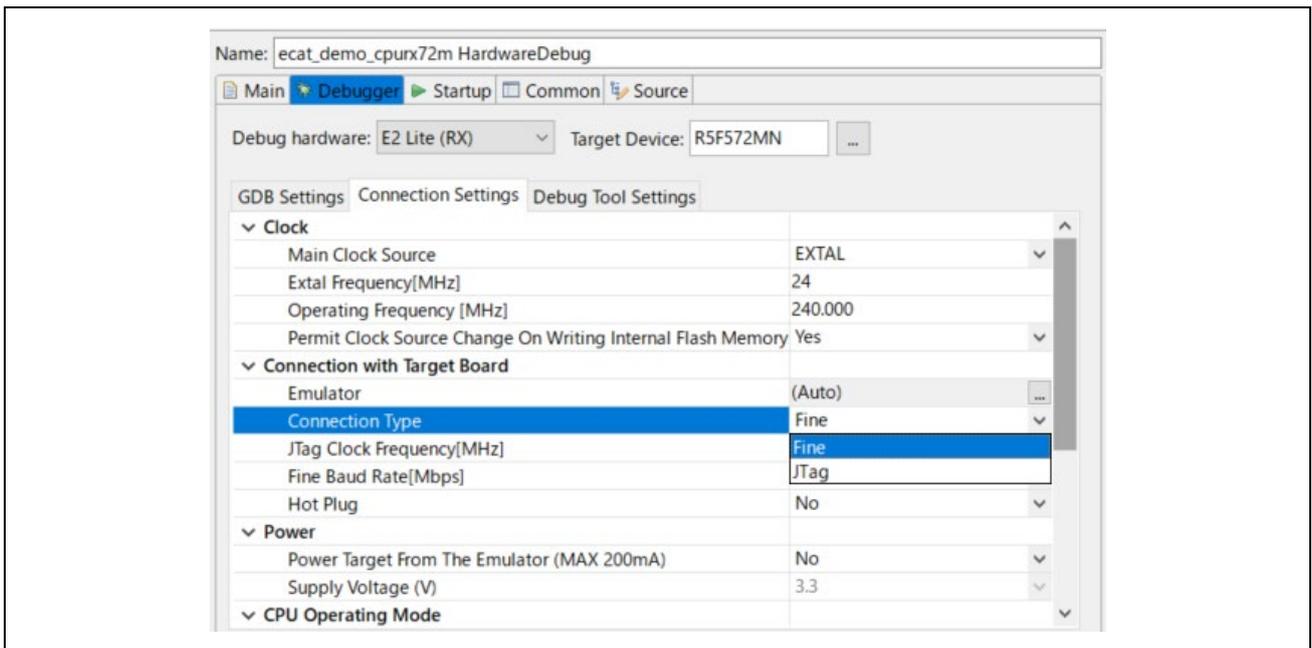
- (2) In the Project Explorer, left click on the "ecat_demo_cpurx72m" project, and select [Build Project] to execute the build.



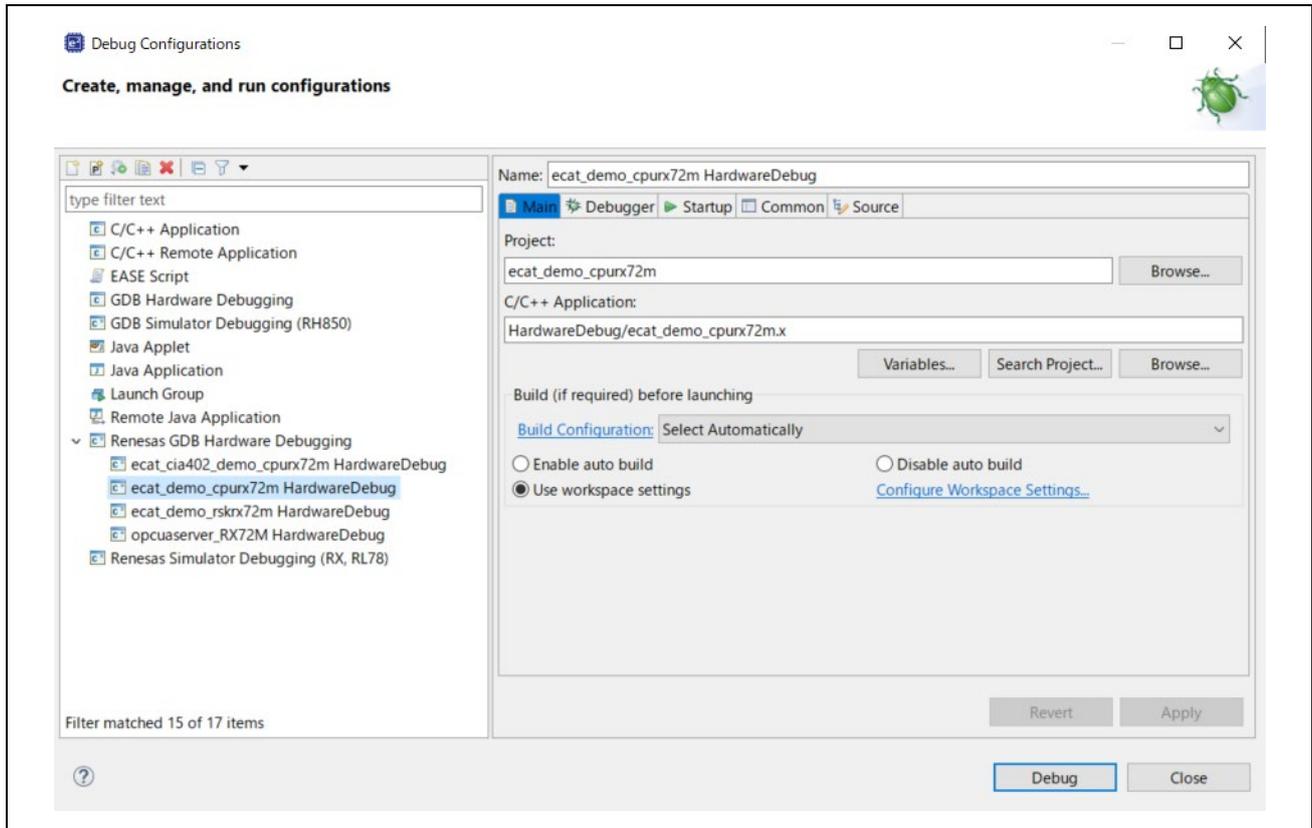
(3) When the build is completed, select [Debug Configuration] from the [Debug] button.



(4) Set up E2OB. E2OB functions as an emulator equivalent to E2Lite, so when connecting, set the emulator type to "E2Lite" and the communication interface to "FINE".



- (5) Click "ecat_demo_cpurx72m Hardware Debug" to download the program to the target and start by pressing the debug button.



- (6) Firewall warning of 'e2 - server - gdb.exe' may be displayed. Check the checkbox of [Private network such as home or workplace network] and click <Allow access>.
- (7) User Account Control (UAC) dialog may be displayed. Enter the administrator password and click [Yes].
- (8) When a dialog recommending the change of perspective is displayed on the confirmation dialog of perspective switching, check the [Always use this setting] checkbox and click [Yes].
- (9) After downloading the code, click the <resume> button and execute the code until the first line of the main function main (.). Click the <resume> button again to execute the target with the rest of the code.

Note): Not use E2OB and run in ROM mode, remove the Debugger switching Jumper pin.

8. Connection with TwinCAT

This section explains how to operate the sample program using TwinCAT3.

8.1 Preparation of ESI file

Before starting TwinCAT please copy the ESI file included in the sample program to the prescribed location of TwinCAT (\TwinCAT\3.x\Config\IO\EtherCAT).

```
ecat_demo_cpurx72m\src\smc_gen\r_ecat_rx\utilities\rx72m\esi\ Renesas EtherCAT RX72M.xml
```

8.2 Starting TwinCAT

- (1) From the start menu, select [Beckhoff] → [TwinCAT 3] → [TwinCAT XAE (VS 20 xx)].
- (2) After starting the program, create a new project of type TwinCAT XAE Project as [File] → [New] → [Project].

8.3 Scanning the network

- (1) In the System Manager tree, right-click [I / O] → [Devices] and select [Scan].
- (2) Click [OK] on the [HINT: Not all types of devices can be found automatically] dialog
- (3) In the [new I / O devices found] dialog box, select the check box of the Ethernet adapter to be scanned and click [OK].
- (4) Clicking [Yes] in the [Scan for Boxes] dialog starts scanning and the devices in the EtherCAT segment are automatically recognized.
- (5) "Active Free Run" dialog is displayed and click [Yes].
In the system manager tree, if Box is added as "Device1" → "Box1" under "I/O" → "Devices", it is normal.

8.4 Writing of SII EEPROM

* Because the EEPROM is blank at the time of shipment of the communication board, be sure to perform writing.

* If the EEPROM has been written, the processing in this section is unnecessary.

If the EEPROM is blank, it is displayed as "Box 1 (PFFFFFFF RFFFFFFF)" in the system manager tree.

- (1) Double-click [Box 1] in the System Manager tree, the panel will be displayed on the right side.
- (2) Select the [EtherCAT] tab and click the [Advanced Settings] button.
- (3) Select [ESC Access] -> [EEPROM] -> [Hex Editor] in the left tree of the Advanced Settings dialog.
- (4) In the [Hex Editor] dialog, select "Download from list".
- (5) In the [Write EEPROM] dialog box, select [Renesas Electronics Corp.] → [Renesas RX 72 M Group] → [Renesas EtherCAT RX 72 M]] and click [OK]. The EEPROM is written.
- (6) After writing, restart the communication board (turn the power supply on again or reset), so that the rewritten data is reflected in the operation of the microcomputer.

8.5 Rescan of the device

- (1) Press the [Restart TwinCAT (Config Mode)] button.
- (2) In the [RestartTwinCAT Sysytem in Config Mode] dialog box, click [OK].
- (3) In the [Load I / O Devices] dialog box, click [Yes].
- (4) Click [Yes] in the [Active Free Run] dialog.
It is OK if "Box 1" in the system manager tree is "Box 1 (Renesas EtherCAT RX 72 M)".

8.6 I/O operation confirmation

- (1) Double-click "Box 1" in the System Manager tree, the panel will be displayed on the right side.
- (2) Select the "Online" tab and make sure "Current Status" is "OP".
- (3) Expand the + next to "Box 1" in the System Manager tree.
- (4) Select "TxPDO-Map" → "Input Counter" and select the "Online" tab on the right-side panel to display "Value".
Check that the value is set by DEVICE ID Jumper pin.
- (5) Select "RxPDO - Map" -> "Output Counter" in the system manager tree and "Value" is displayed when you select the "Online" tab on the right panel.
Make sure that "0" is displayed.
- (6) Click [Write] and enter an arbitrary numerical value in the "Set Value Dialog" dialog.
- (7) Click "OK" and confirm that the value "Value" is the entered value.
Lower 4 bits of the entered value is displayed on LED4-1 of the communication board.
(LED lights up when bit = 1)

9. Appendix Conversion procedure to the IAR project

Download and install IAR Embedded Workbench for Renesas RX (V5.10.1 or later) for RX72M from the IAR Systems website.

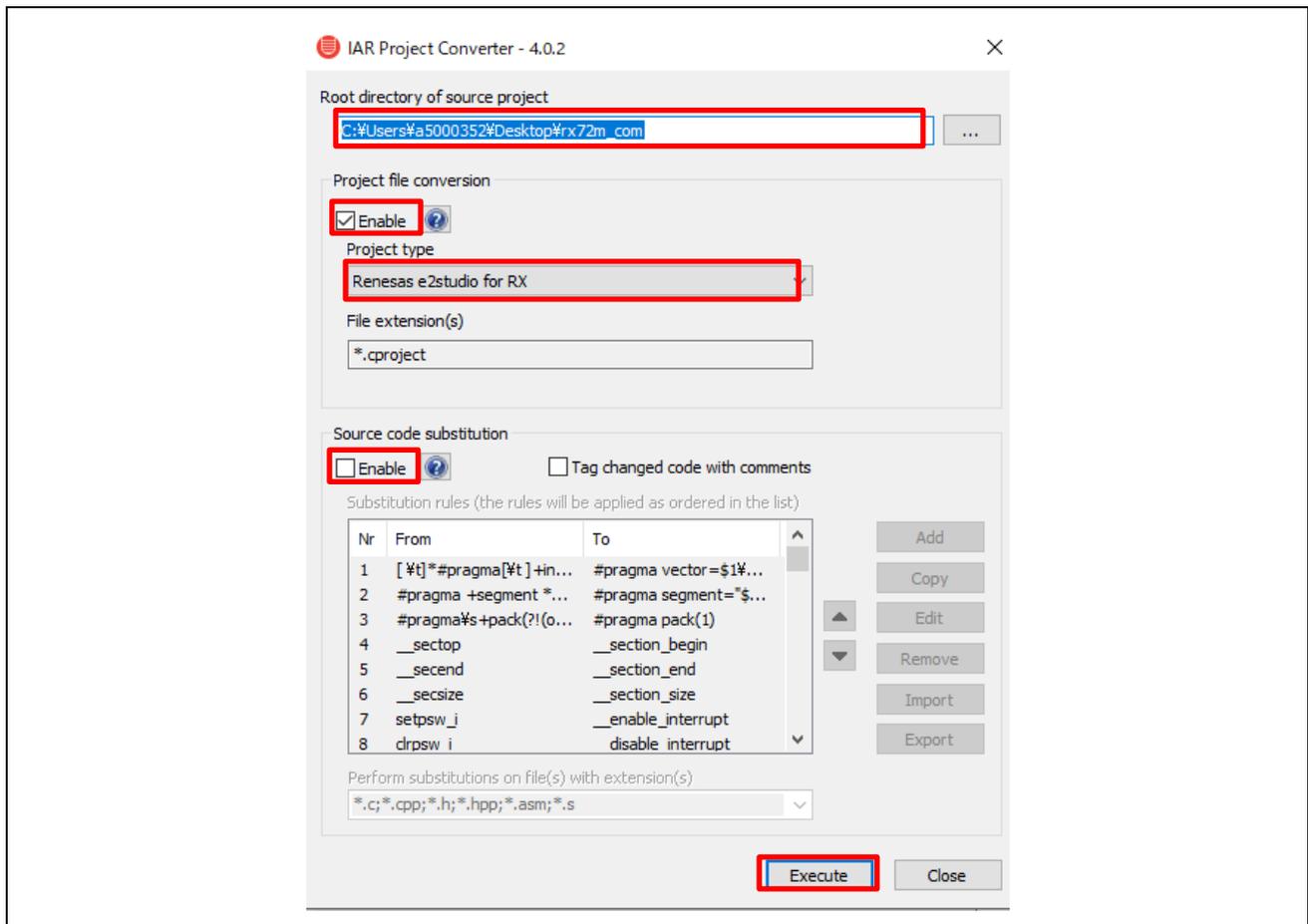
<https://www.iar.com/jp/>

Also, Download and install Smart Configurator for RX (V2.19.0 or later) from the following website.

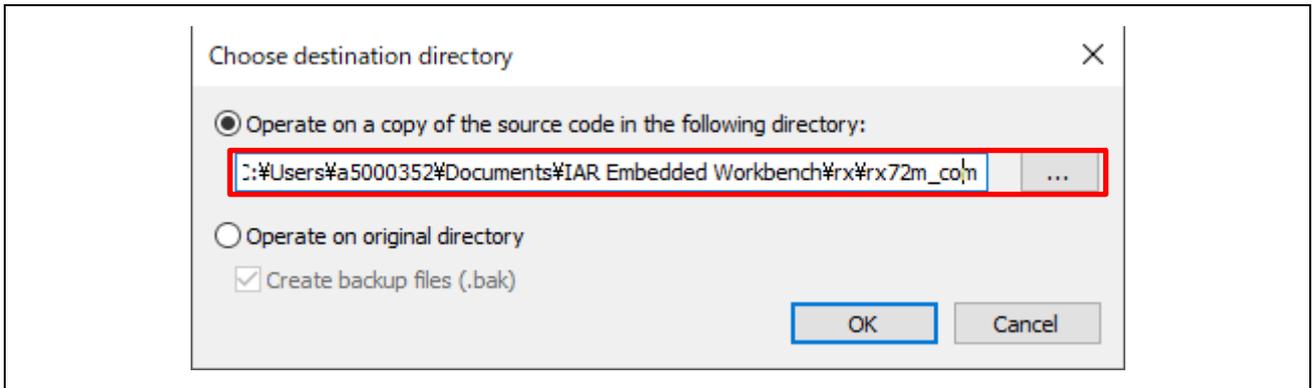
<https://www.renesas.com/jp/ja/software-tool/rx-smart-configurator>

This section describes the procedure for converting an e2 studio version project to an IAR project.

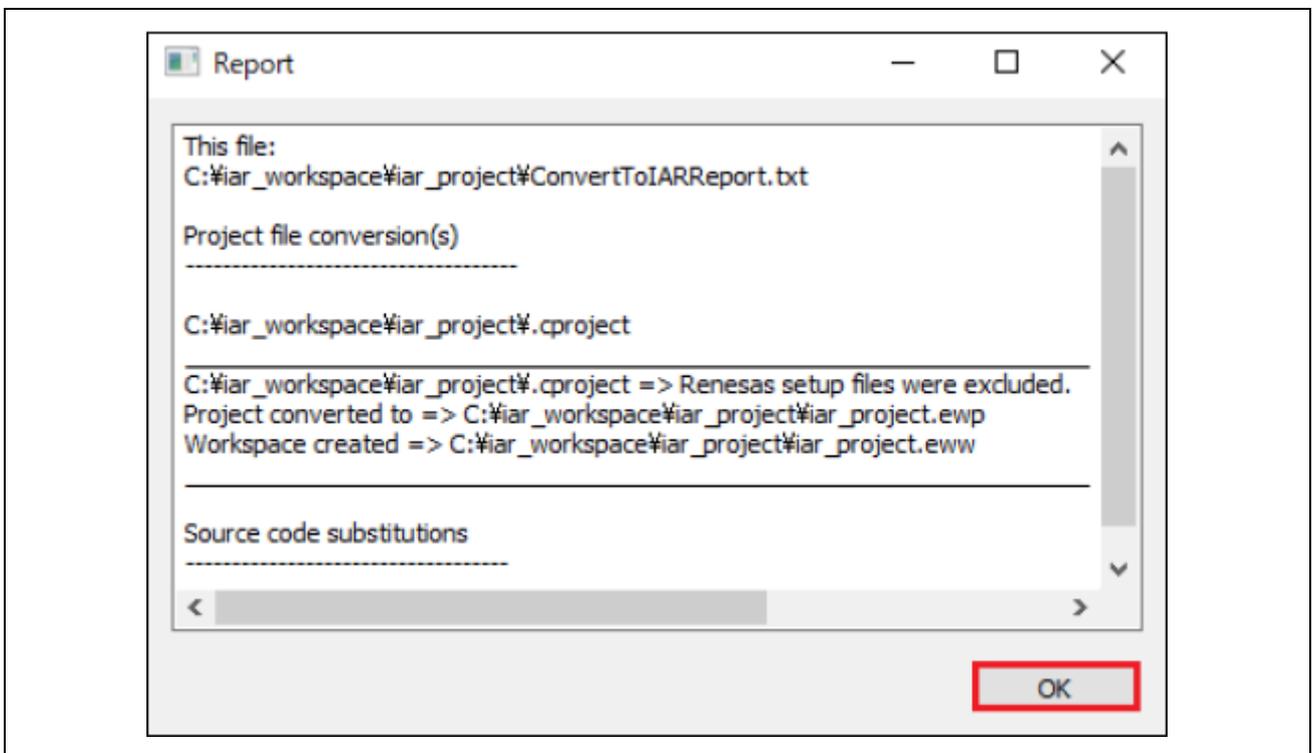
- (1) Start IAR Embedded Workbench for Renesas RX.
- (2) Click "Tools >> Convert To IAR for RX ...".
- (3) Select "ecat_demo_cpurx72" in the e2 studio version sample program directory in the Root directory of source project.
- (4) Select the "Enable" check box for Project file conversion.
- (5) Select "Renesas e2studio for RX" in Project type.
- (6) Uncheck the check box of "Enable" in the Source code substitution.
- (7) Click "Execute"



- (8) In the Choose destination directory window, select the "Operate on a copy of the source code in the following directory" checkbox. Please freely select the destination directory.



- (9) Click "OK" in the Report window.



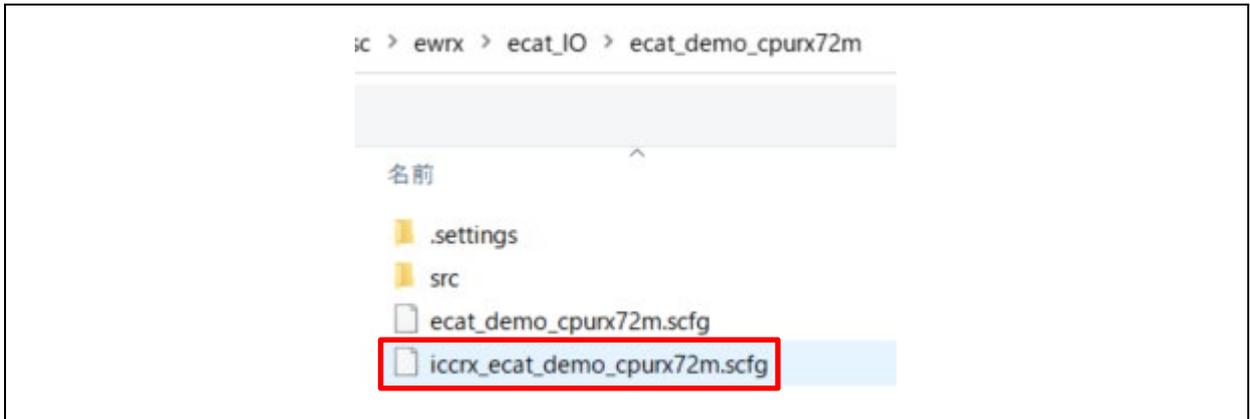
Please leave IAR Embedded Workbench for Renesas RX running.

(10) Then start Smart Configurator for RX.

The EtherCAT FIT module is not included in the RX Driver package, so you need to manually install in the Smart Configurator for RX when you start it for the first time.

For details, refer to Chapter 6.3 of "r01an4881xx0131-rx-ecat.pdf" in advance and incorporate the module.

(11) Click "File >> Open" and select iccrx_ecat_demo_cpurx72m.scfg in the destination directory.



(12) When the configuration window is displayed, execute "Generate Code".

You can exit the Smart Configurator for RX.

(13) Return to IAR Embedded Workbench for Renesas RX.

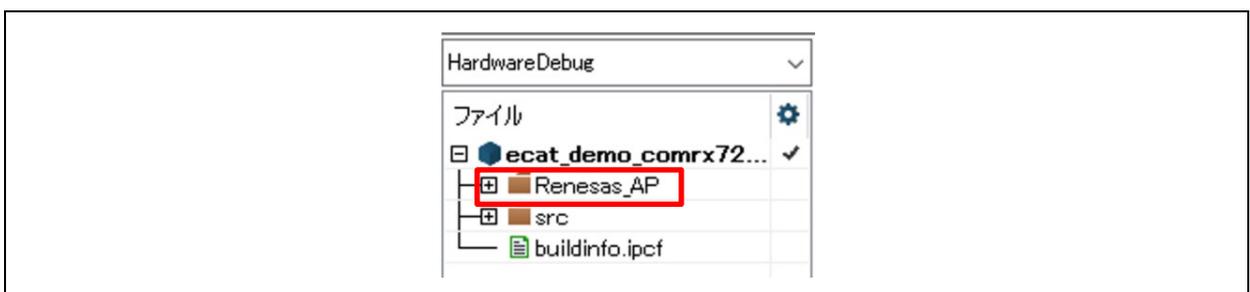
Click "File >> Open Workspace " to open the .eww file in the destination directory for the IAR project.

(14) Click "Project >> Add Project Connection ".

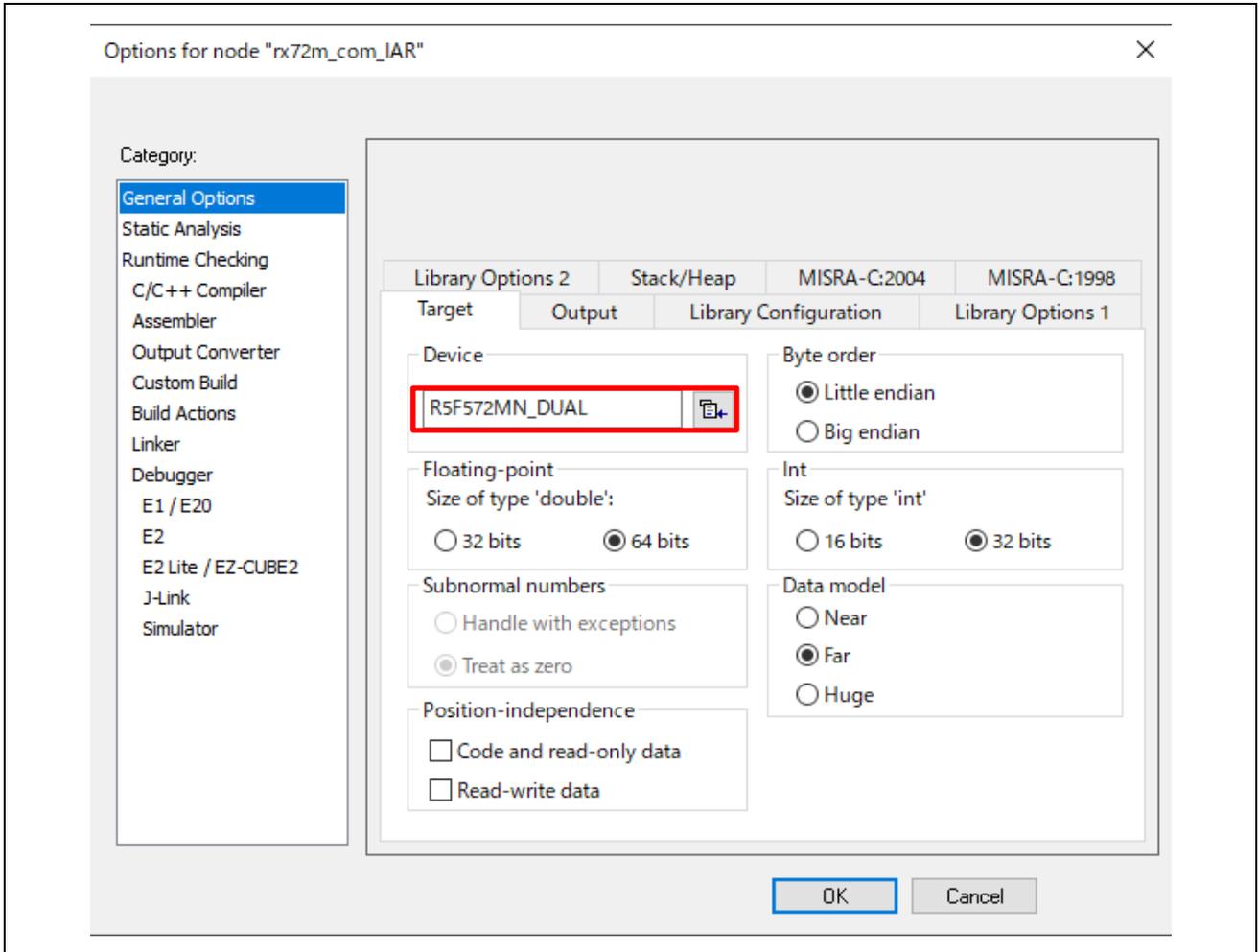
Select "IAR Project Connection File" as the connection to use and click "OK".

Select buildinfo.ipcf and click "Open".

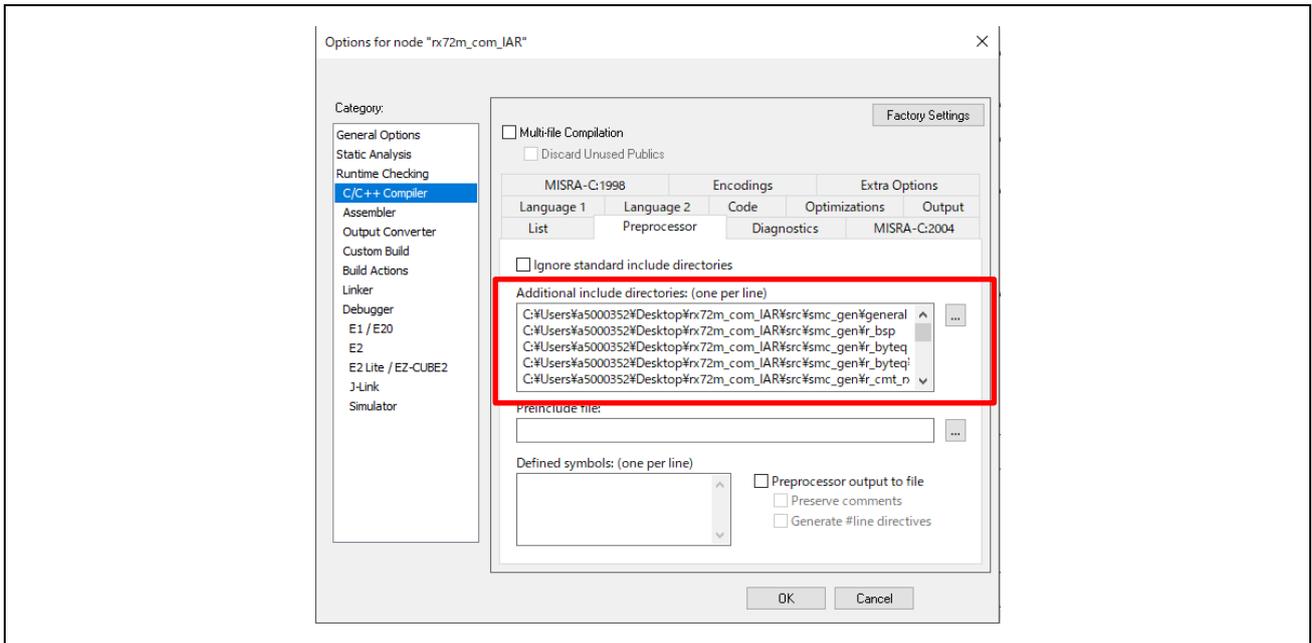
The file generated by Smart Configurator for RX will be imported.



- (15) Right click on the project and click "Options".
- (16) Select "Target" on the General Options tab.
- (17) Select "Device to use". In case of RX72M, it is "R5F572MN_DUAL"



- (18) Select "Preprocessor" in the C / C ++ Compiler tab and set the same include path as the CCRX project.

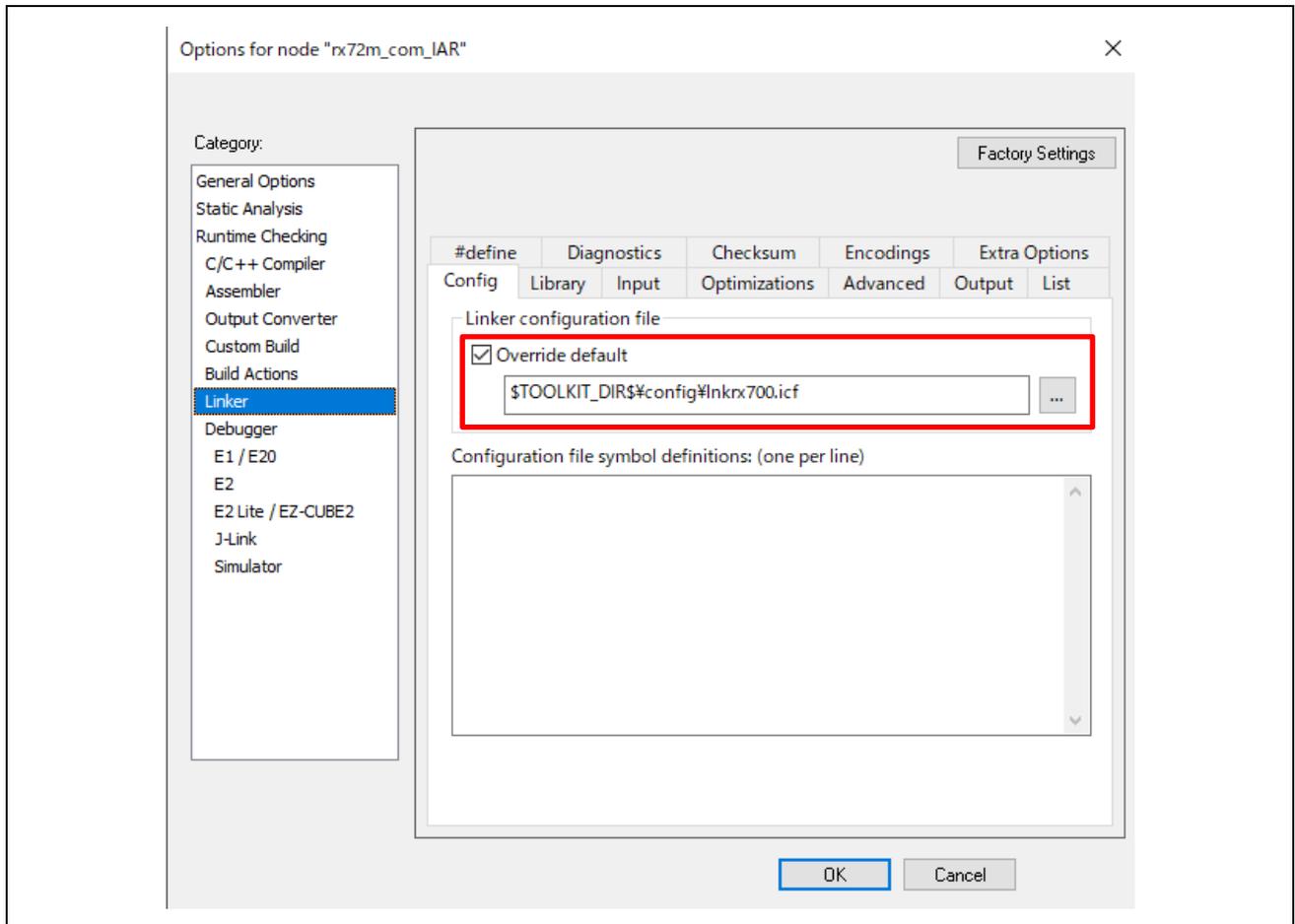


Set up under \ src according to the project directory.

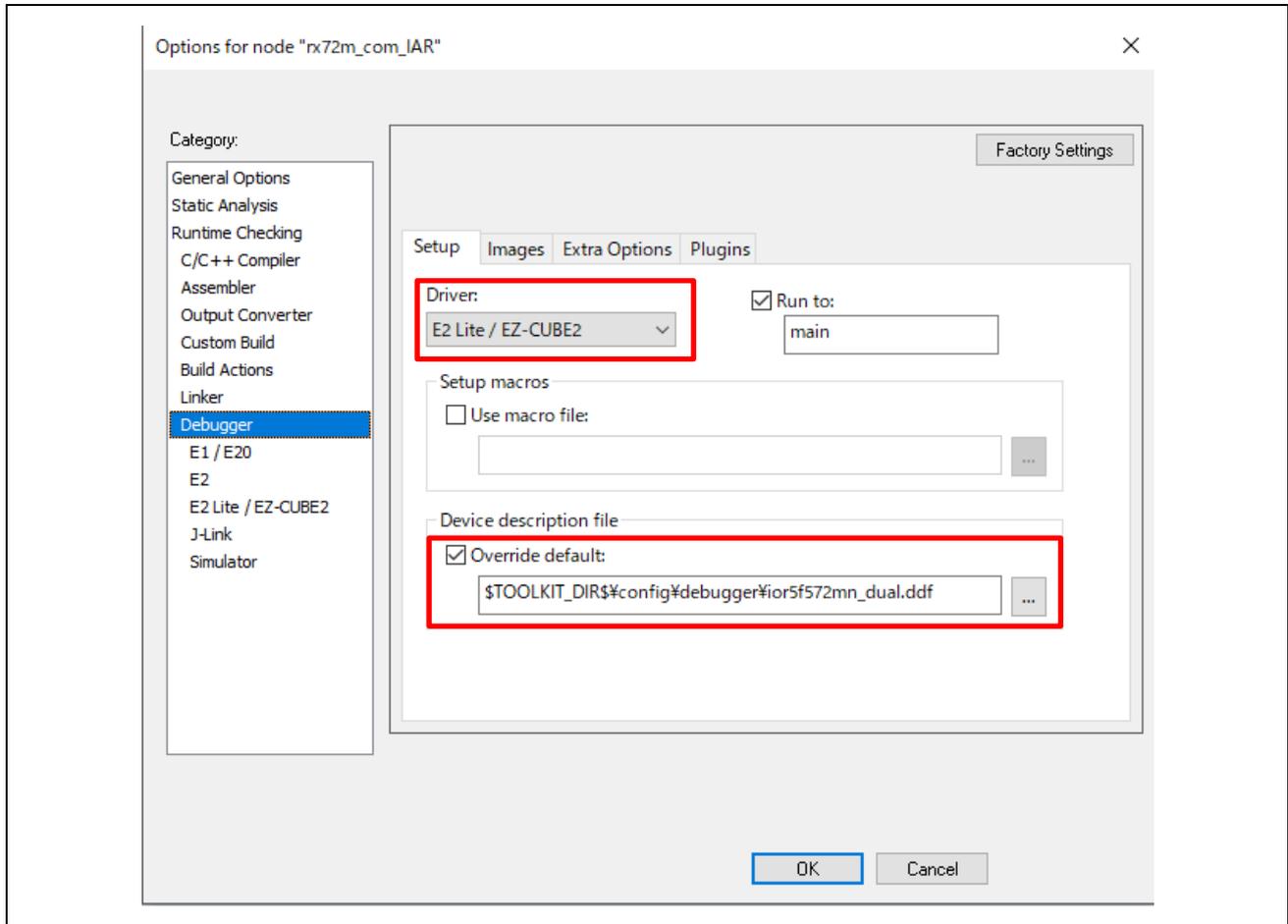
`$PROJ_DIR$\src\application\ecat\beckhoff\Src`

`$PROJ_DIR$\src\application\ecat`

- (19) Select "Settings" on the Linker tab. Set the "Default Override" checkbox in the linker configuration file. Next, select ".icf file of target device". Please set "lnkrx700.icf" for RX72M.



- (20) Select "Settings" on the debugger tab. Select "Emulator" in the driver. RX72M is "E2 Lite / EZ-CUBE2". · · Select "Default Override" in the device description file. RX72M is "ior5f572mn_dual.ddf".



- (21) Click "Project >> Rebuild All".
- (22) Click "E2 / E2 Lite >> Hardware Settings ...".
- (23) Set the following items in the Hardware Setup window and click OK.
- Check "EXTAL frequency" and set the frequency to 24MHz.
 - Select "FINE baud rate" of Communication item and set the baud rate to 1.5Mbps.
- (24) Click "Project >> Download and Debug".

10. Appendix e2studio setting information

This section describes the e2 studio settings for configuring the sample program.

Please use it as a reference when creating a new project and adding the functions of the sample program.

10.1 FIT module Structure

The sample program consists of the following FIT modules.

Table 10-1 FIT Module Structure

Type	Module name	FIT module name
Board Support Package	Board Support Package (BSP)	r_bsp
Device Driver	Compare Match Timer (CMT)	r_cmt_rx
Device Driver	Serial Communication Interface (SCI)	r_sci_rx
Middleware	Byte Type Queue buffer (BYTEQ)	r_byteq
Device Driver	EtherCAT	r_ecat_rx

10.2 Configuration options

The configuration file of the FIT module has been changed.

And the definitions for pins assignment of DIP switch input and LED output used in the EtherCAT application has been changed.

The changes to the configuration options are shown below.

(1) EtherCAT FIT module settings change

Set the PHY LSI to be used to the KSZ8081MNX mounted on the communication board.

Also, set the PHY reset waiting time to 500 μ s.

【 r_config/r_ecat_config.h 】

Macro Name	Setting
ECAT_CFG_USE_SUPPORTED_PHY	2
ECAT_CFG_PHY_DELAY_RESET	500

(2) SCI FIT module settings change

Set CH6 and send completion interrupts to enable.

【 r_config/r_sci_rx_config.h 】

Macro Name	Setting
SCI_CFG_CH6_INCLUDED	1
SCI_CFG_TEI_INCLUDED	1

(3) EtherCAT application settings change

Set the DIP switch input and LED output pins assignment for the communication board.

【 application/ecat/sampleappl.c 】

Macro Name	Setting
APPL_CFG_LED_SW	3

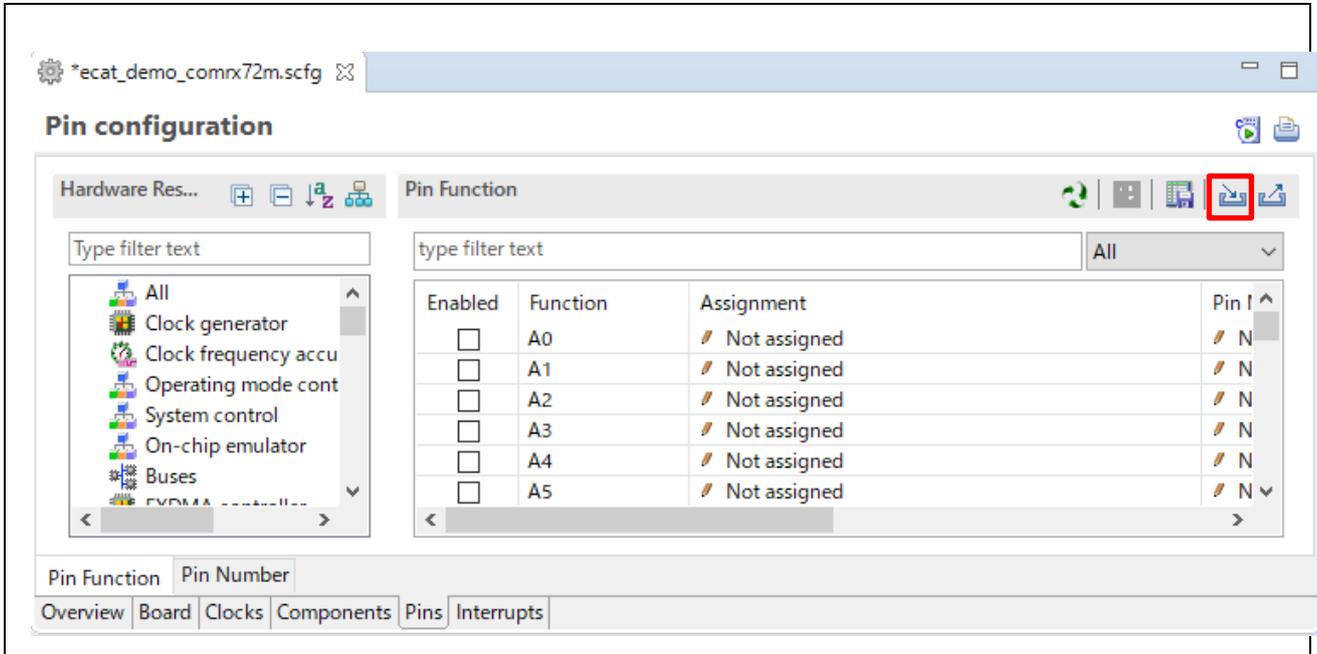
10.3 Pin configuration

You can import the pin settings to run the sample program on the communication board.

Click the [Import the board setting] button on the [Pins] tab of the Smart Configurator.

Then select "ecat_demo_cpurx72m_board.xml".

The xml file is included in the sample program.



Enable the pins used by the FIT module in the [Resources] property of the [Components] tab.

Components	Resources to enable	Pins to enable
r_ecat\rx	ESC ESC_MII0 ESC_MII1	All pins
r_sci_rx	SCI6	RXD6/SMISO6 pin TXD6/SMOSI6 pin

10.4 Build configuration

The settings when building the sample program are shown below.

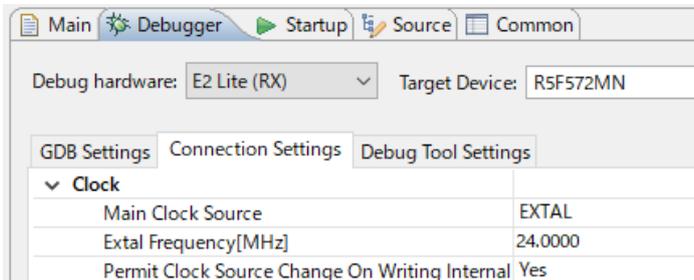
Table 10-2 Setting Tool Tab

Item	Changing Contents	Description
Compiler - Source	Include path by [Include · File · Directory]	In each FIT module, for the setting please add the required include path. When installed each FIT module by using [FIT Configuration] it will be automatically set. Add the include path of sample program. In this project, "application\ecat\beckhoff\Src" and "application\ecat\renesas" are added. < Example Setting > <div style="border: 1px solid gray; padding: 5px; margin: 5px 0;"> Include file directories   </div> <pre> "\${workspace_loc}/\${ProjName}/src/application/ecat/beckhoff/Src" "\${workspace_loc}/\${ProjName}/src/application/ecat/renesas" </pre>
Compiler – Optimization	Change optimization level Level 1: Implement a part of the optimization	To prevent the building by optimization from some code that generate by SSC, set optimization level 1

10.5 Debug configuration

The settings for debugging the sample program on the communication board are shown below.

Table 10-3 Debug configuration

Tab Item	Changing Contents	Description
Debugger – Connection Settings	Set the EXTAL frequency to 24MHz and don't turned on the power from the emulator. < Setting > 	

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Jan 31, 2023	-	First edition issued
1.01	Nov 30, 2023	Program	Modify ESI file to support CTT V2.4.0
		16-22	Change "9. Appendix Conversion procedure to IAR project"
		3	Add "Smart Configurator for RX" to Table 1.1 "Operating environment"
		3, 5, 6, 16	Update the version of each tool.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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